TECHNICAL DATA DATA SHEET 349, REV -

HERMETIC POWER MOSFET P-CHANNEL

FEATURES:

- -100 Volt, 0.2 Ohm, -18A MOSFET
- Electrically Isolated Hermetically Sealed
- Low R_{DS (on)}
- Equivalent to IRF9140 Series

MAXIMUM RATINGS

ALL RATINGS ARE AT $T_{A} = 25^{\circ}\text{C}$ UNLESS OTHERWISE SPECIFIED.

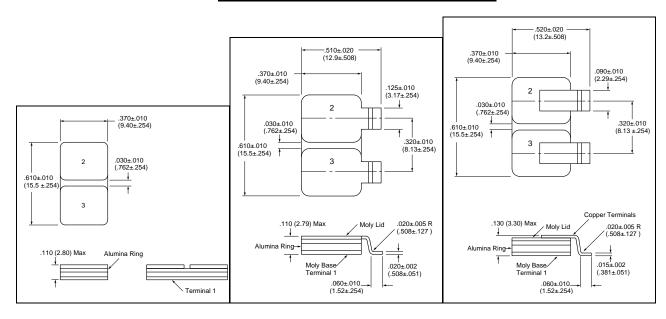
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RATING	SYMBOL	MIN.	TYP.	MAX.	UNITS
GATE TO SOURCE VOLTAGE	V_{GS}	-	-	±20	Volts
CONTINUOUS DRAIN CURRENT V _{GS} =10V, T _C = 25°C	I _D	-	-	-18	Amps
$V_{GS}=10V, T_{C}=100^{\circ}C$				-11	
PULSED DRAIN CURRENT @ $T_C = 25^{\circ}C$	I _{DM}	-	-	-72	Amps
OPERATING AND STORAGE TEMPERATURE	T_{OP}/T_{STG}	-55	-	+150	°C
TERMAL RESISTANCE JUNCTION TO CASE	$R_{ heta JC}$	-	-	0.75	°C/W
TOTAL DEVICE DISSIPATION @ T _C = 25°C	P_{D}	-	-	167	Watts

ELECTRICAL CHARACTERISTICS

DRAIN TO SOURCE BREAKDOWN VOLTAGE	BV _{DSS}	-100	_	_	Volts
$V_{GS} = 0V$, $I_D = 1.0 \text{mA}$	DVDSS	-100		_	VOILS
DRAIN TO SOURCE ON STATE RESISTANCE		_	-	0.20	Ω
$V_{GS} = -10V$, $I_{D} = -11A$	R _{DS(ON)}			0.22	22
$V_{GS} = -10V, I_D = -18A$	D3(ON)			• • • • • • • • • • • • • • • • • • • •	
GATE THRESHOLD VOLTAGE $V_{DS} = V_{GS}$, $I_D = -250\mu A$	$V_{GS(th)}$	-2.0	-	-4.0	Volts
FORWARD TRANSCONDUCTANCE	g _{fs}	6.2	-	-	S(1/Ω)
$V_{DS} \ge -15V$, $I_{DS} = -11A$	O .e				-('')
ZERO GATE VOLTAGE DRAIN CURRENT		-	-		μА
$V_{DS} = 0.8x$ Max. Rating, $V_{GS} = 0V$	I_{DSS}			-25	
$V_{DS} = 0.8x \text{ Max. Rating}$				-250	
$V_{GS} = 0V, T_{J} = 125^{\circ}C$					
GATE TO SOURCE LEAKAGE FORWARD V _{GS} = -20V	I _{GSS}	-	-	-100	nA
GATE TO SOURCE LEAKAGE REVERSE V _{GS} = 20V				100	
TOTAL GATE CHARGE V _{GS} = -10V	Q _q	31	-	60	nC
GATE TO SOURCE CHARGE $V_{DS} = Max. Ratingx0.5$	Q_{gs}	3.7		13	
GATE TO DRAIN CHARGE $I_D = -18A$	Q_{gd}	7.0		35.2	
TURN ON DELAY TIME $V_{DD} = -50V$,	$t_{d(on)}$	-	-	35	nsec
RISE TIME $I_D = -11A$,	t _r			85	
TURN OFF DELAY TIME $R_G = 9.1\Omega$	$t_{d(off)}$			85	
FALL TIME	t _f			65	
DIODE FORWARD VOLTAGE $T_J = 25^{\circ}C$, $I_S = -18A$,	V_{SD}	-	-	-4.2	Volts
$V_{GS} = 0V$					
DIODE REVERSE RECOVERY TIME $T_J = 25$ °C,	t _{rr}	-	-	280	nsec
REVERSE RECOVERY CHARGE $I_F = -18A$,					
$di/dt = -100A/\mu sec,$	_				
$V_{DD} \le -50V$	Q_{rr}			3.6	μС
INPUT CAPACITANCE $V_{GS} = 0 V$,	C_{iss}	-	1400	-	рF
OUTPUT CAPACITANCE $V_{DS} = 25 \text{ V},$	C_{oss}		600		
REVERSE TRANSFER CAPACITANCE f = 1.0MHz	C_{rss}		200		
DRAIN TO CASE CAPACITANCE	C_{DC}		12		

SENSITRON DATA SHEET 349 REVISION -

MECHANICAL DIMENSIONS: in Inches / mm



SHD-5A SHD-5B

PINOUT TABLE

DEVICE TYPE	PIN 1	PIN 2	PIN 3
MOSFET	DRAIN	SOURCE	GATE
SHD-5/A/B PACKAGE			

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